

STRUCTURE            Silicon Monolithic Integrated Circuit

TYPE                    Reference Voltage Regulator

PRODUCT SERIES     **B D 3 5 7 3 H F P**

FEATURES             1.3.3V output voltage/ Low dropout voltage/ Low quiescent current  
 2.Built-in Overcurrent protection circuit/ Thermal shutdown circuit

○ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Parameter	Symbol	Limit	Unit
Supply Voltage	Vcc	50 ※1	V
Switch Supply Voltage	Vsw	50 ※1	V
Power Dissipation	Pd	1.6 ※2	W
Operating Temperature Range	Topr	-40~+125	°C
Storage Temperature Range	Tstg	-55~+150	°C
Maximum Junction Temperature	Tjmax	150	°C

※1 Not to exceed Pd and ASO.

※2 Reduced by 12.8mW/°C over Ta=25°C , when mount on a glass epoxy board:70mm×70mm×1.6mm.

○OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Unit
Supply Voltage	Vcc	4.5 ※3	36.0	V
Switch Supply Voltage	Vsw	0	Vcc	V
Output Current	Io	—	500	mA

※3 Please consider that the Output voltage would be dropped (Dropout voltage) according to the Output current.

Status of this document

The Japanese version of this document is the formal specification.

A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document, formal version takes priority.

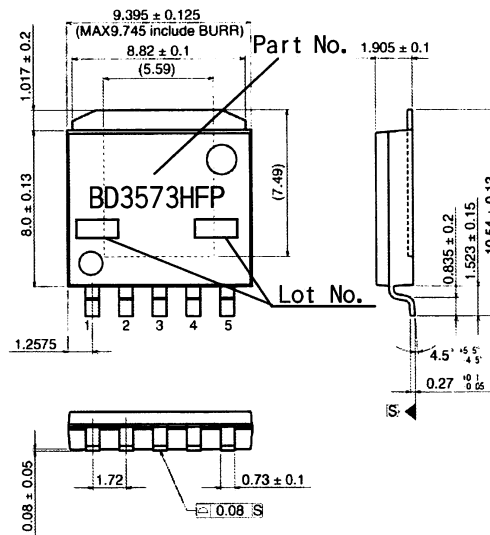
○ELECTRICAL CHARACTERISTICS (Unless otherwise specified,  $T_a = -40 \sim 125^\circ\text{C}$ ,  $V_{cc} = 13.2\text{V}$ ,  $SW = 3\text{V}$ )

Parameter	Symbol	Limits			Unit	Conditions
		MIN	Typ	MAX		
Shut Down Current	Ishut	—	—	10	$\mu\text{A}$	SW=GND
Bias Current	Ib	—	30	50	$\mu\text{A}$	$I_o = 0\text{mA}$
Output Voltage	$V_o$	3.234	3.300	3.366	V	$I_o = 200\text{mA}$
Output Current	$I_o$	0.5	—	—	A	
Ripple Rejection	R.R.	45	55	—	dB	$f = 120\text{Hz}$ , $e_{in} = 1\text{V}_{\text{rms}}$ , $I_o = 100\text{mA}$
Line Regulation	Reg. I	—	10	30	mV	$5.5\text{V} \leq V_{cc} \leq 25\text{V}$ , $I_o = 0\text{mA}$
Load Regulation	Reg. L	—	20	40	mV	$0\text{mA} \leq I_o \leq 200\text{mA}$
Switch Threshold Voltage H	SWH	2.0	—	—	V	$I_o = 0\text{mA}$
Switch Threshold Voltage L	SWL	—	—	0.5	V	$I_o = 0\text{mA}$
Switch Bias Current	SWI	—	22	60	$\mu\text{A}$	SW=5V, $I_o = 0\text{mA}$

This product is not designed for protection against radio active rays.

NOTE) All characteristics are measured with  $0.33 \mu\text{F}$  and  $0.1 \mu\text{F}$  capacitors connected to input and output pins, respectively. Because measurements (pulse measurements) were taken when  $T_a = T_j$ , data other than the temperature coefficient of Output voltage does not include fluctuations due to temperature variations.

○PHYSICAL DIMENSIONS • MARKING



HRP-5 (Unit : mm)



10) Thermal shutdown circuit (TSD)

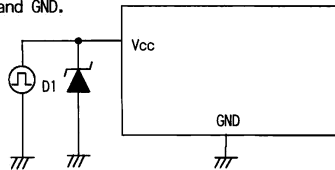
This IC incorporates a built-in TSD circuit for the protection from thermal destruction. The IC should be used within the specified power dissipation range. However, in the event that the IC continues to be operated in excess of its power dissipation limits, the attendant rise in the junction temperature ( $T_j$ ) will trigger the TSD circuit to turn off all output power elements(175°C:Typ). The circuit automatically resets once the junction temperature ( $T_j$ ) drops (150°C:Typ). Operation of the TSD circuit presumes that the IC's absolute maximum ratings have been exceeded. Application designs should never make use of the TSD circuit.

11) Overcurrent protection circuit (OCP)

The IC incorporates a built-in overcurrent protection circuit that operates according to the output current capacity. This circuit serves to protect the IC from damage when the load is shorted. The protection circuit is designed to limit current flow by not latching in the event of a large and instantaneous current flow originating from a large capacitor or other component. This protection circuits is effective in preventing damage due to sudden and unexpected accidents. However, the IC should not be used in applications characterized by the continuous operation or transitioning of the protection circuits. At the time of thermal designing, keep in mind that the current capacity has negative characteristics to temperatures.

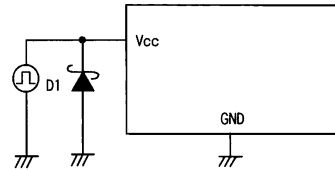
12) About positive surge voltage

To protect against a surge voltage that exceeds 50V between Vcc and GND please insert a power zener diode between Vcc terminal and GND.



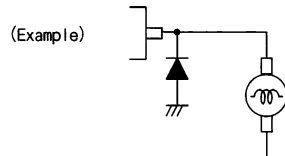
13) About negative surge voltage

To protect against a negative surge voltage, please insert a Schottky diode between the Vcc terminal and GND.



14) We recommend using Diode for protection purpose when the temperature so output voltage is off.

This is to prevent against large loads of impedance or reverse current during initial stages or output off stage.



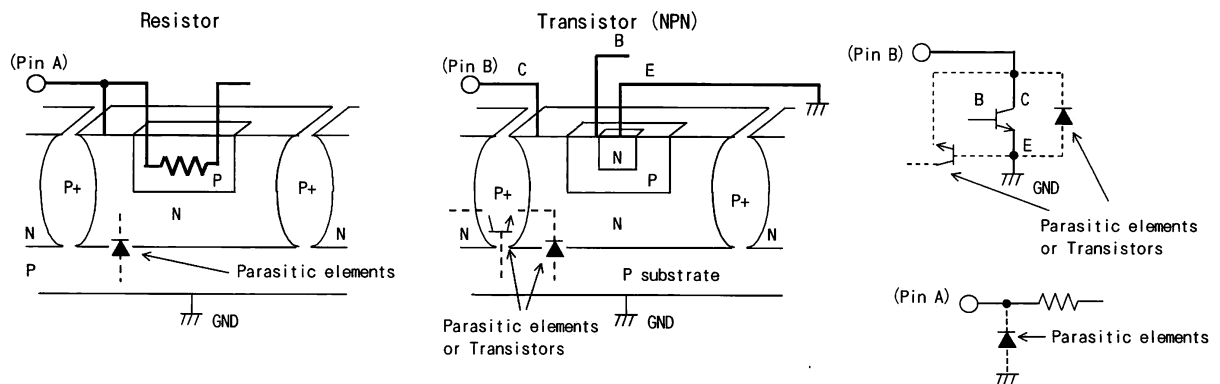
15) This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated.

P/N junctions are formed at the intersection of these P layers with the N layers of other elements to create a variety of parasitic elements. For example, when the resistors and transistors are connected to the pins as shown in the following figure,

○The P/N junction functions as a parasitic diode when GND > Pin A for the resistor or GND > Pin B for the transistor (NPN).

○Similarly, when GND > Pin B for the transistor (NPN), the parasitic diode described above combines with the N layer of other adjacent elements to operate as a parasitic NPN transistor.

The formation of parasitic elements as a result of the relationships of the potentials of different pins is an inevitable result of the IC's architecture. The operation of parasitic elements can cause interference with circuit operation as well as IC malfunction and damage. For these reasons, it is necessary to use caution so that the IC is not used in a way that will trigger the operation of parasitic elements, such as by the application of voltages lower than the GND (P substrate) voltage to input pins. Keep in mind that the IC may malfunction in strong magnetic fields.



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